Celanese
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HOSTAFORM® C 9021 GV1/30

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Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988- POM-K, M-GNR, 02-003, GF26 POM copolymer Injection molding type, reinforced with ca 26 % glass fibers; high resistance to thermal and oxidative degradation; reduced thermal expansion and shrinkage. UL-registration for all colours and a thickness more than 1.57 mm as UL 94 HB, temperature index UL 746 B electrical 105 °C, mechanical 95 °C (tensile impact) and 100 °C (tensile). Burning rate ISO 3795 and FMVSS 302 < 100 mm/min and a thickness more than 1 mm thickness. Ranges of applications: For molded parts with very high strength and rigidity as well as higher hardness. FMVSS = Federal Motor Vehicle Safety Standard (USA) UL = Underwriters Laboratories (USA)

Product information

Resin Identification	POM-GF26	ISO 1043
Part Marking Code	>POM-GF26<	ISO 11469

Rheological properties

Melt volume-flow rate	4	cm^3/10min	ISO 1133
Temperature	190	°C	
Load	2.16	kg	
Moulding shrinkage, parallel	0.6	%	ISO 294-4, 2577
Moulding shrinkage, normal	1.0	%	ISO 294-4, 2577

Typical mechanical properties

Tensile modulus	9200	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	135	MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	2.5	%	ISO 527-1/-2
Flexural modulus	7800	MPa	ISO 178
Flexural strength	160	MPa	ISO 178
Tensile creep modulus, 1h	7700	MPa	ISO 899-1
Tensile creep modulus, 1000h	5400	MPa	ISO 899-1
Charpy impact strength, 23°C	30	kJ/m^2	ISO 179/1eU
Charpy impact strength, -30°C	35	kJ/m^2	ISO 179/1eU
Charpy notched impact strength, 23°C	8	kJ/m^2	ISO 179/1eA
Charpy notched impact strength, -30°C	8	kJ/m^2	ISO 179/1eA
Ball indentation hardness, H 358/30	200	MPa	ISO 2039-1
Poisson's ratio	0.392		

Thermal properties

Melting temperature, 10°C/min	166	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	160	°C	ISO 75-1/-2
Temperature of deflection under load, 8 MPa	125	°C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	40	E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	80	E-6/K	ISO 11359-1/-2
Thermal conductivity of melt	0.215	W/(m K)	ISO 22007-2
Effective thermal diffusivity, flow	6.51E-8	m^2/s	ISO 22007-4
Specific heat capacity of melt	1810	J/(kg K)	ISO 22007-4

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Flammability

Burning Behav. at 1.5mm nom. thickn.	HB	class	IEC 60695-11-10
Thickness tested	1.6	mm	IEC 60695-11-10
Burning Behav. at thickness h	HB	class	IEC 60695-11-10
Thickness tested	3.18	mm	IEC 60695-11-10
UL recognition	yes		UL 94

Electrical properties

Relative permittivity, 100Hz	4.3		IEC 62631-2-1
Relative permittivity, 1MHz	4.3		IEC 62631-2-1
Dissipation factor, 100Hz	30	E-4	IEC 62631-2-1
Dissipation factor, 1MHz	60	E-4	IEC 62631-2-1
Volume resistivity	1E12	Ohm.m	IEC 62631-3-1
Surface resistivity	1E14	Ohm	IEC 62631-3-2
Electric strength	40	kV/mm	IEC 60243-1
Comparative tracking index	600		IEC 60112

Physical/Other properties

Humidity absorption, 2mm	0.17	%	Sim. to ISO 62
Water absorption, 2mm	0.9	%	Sim. to ISO 62
Density	1600	kg/m³	ISO 1183

Injection

Drying Recommended	no	
Drying Temperature	100	°C
Drying Time, Dehumidified Dryer	3 - 4	h
Processing Moisture Content	≤0.2	%
Melt Temperature Optimum	200	°C
Min. melt temperature	190	°C
Max. melt temperature	210	°C
Screw tangential speed	≤0.3	m/s
Mold Temperature Optimum	100	°C
Min. mould temperature	80	°C
Max. mould temperature	120	°C
Hold pressure range	60 - 120	MPa
Back pressure	2	MPa
Ejection temperature	133	°C

Characteristics

Processing	Injection Moulding
Delivery form	Pellets
Additives	Release agent

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Additional information

Injection molding

Preprocessing

General drying is not necessary due to low moisture absorption of the resin.

In case of bad storage conditions (water contact or condensed water) the use of a recirculating air dryer (100 to 120 °C / max. 40 mm layer / 3 to 6 hours) is recommended.

Max. Water content 0,2 %

Processing

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes

Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Storage

The product can then be stored in standard conditions until processed.

Automotive

OEM	STANDARD	ADDITIONAL INFORMATION
BMW	GS93016	
Bosch	N28 BN22-X010	Natural
Bosch	N28 BN22-X010	Black
Continental	TST N 055 54.10	
General Motors	GMW17968P-POM-GF25	Natural
Mercedes-Benz	DBL5403	(5401.00)
Mercedes-Benz	DBL5406	(5406.00)
Mercedes-Benz	DBL5410	(5410.00)
Mercedes-Benz	DBL5420	(5420.00)

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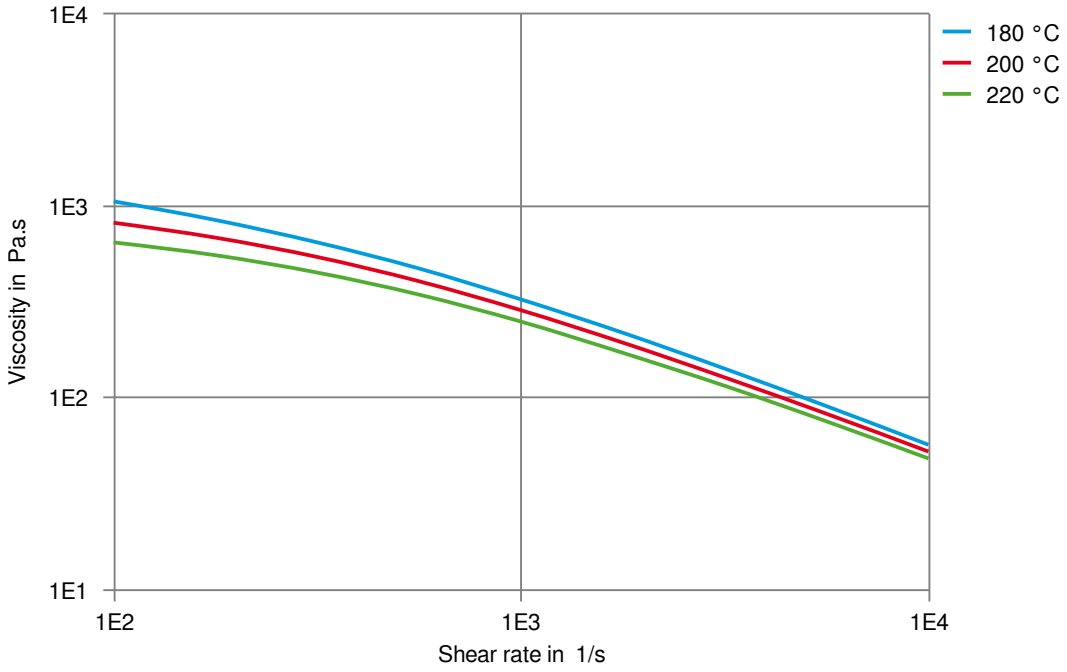
Stellantis - Chrysler	MS.50095 / CPN-4291	Natural
VW Group	No Spec, Special Part Approval, See Your CE Account Manager.	

Viscosity-shear rate



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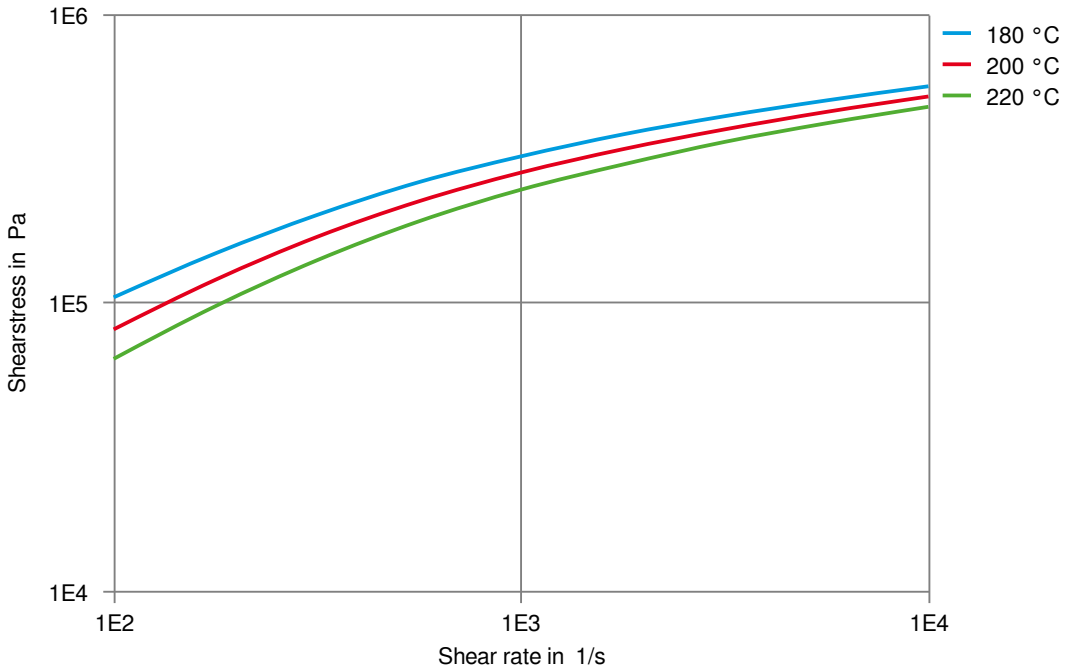
Shearstress-shear rate



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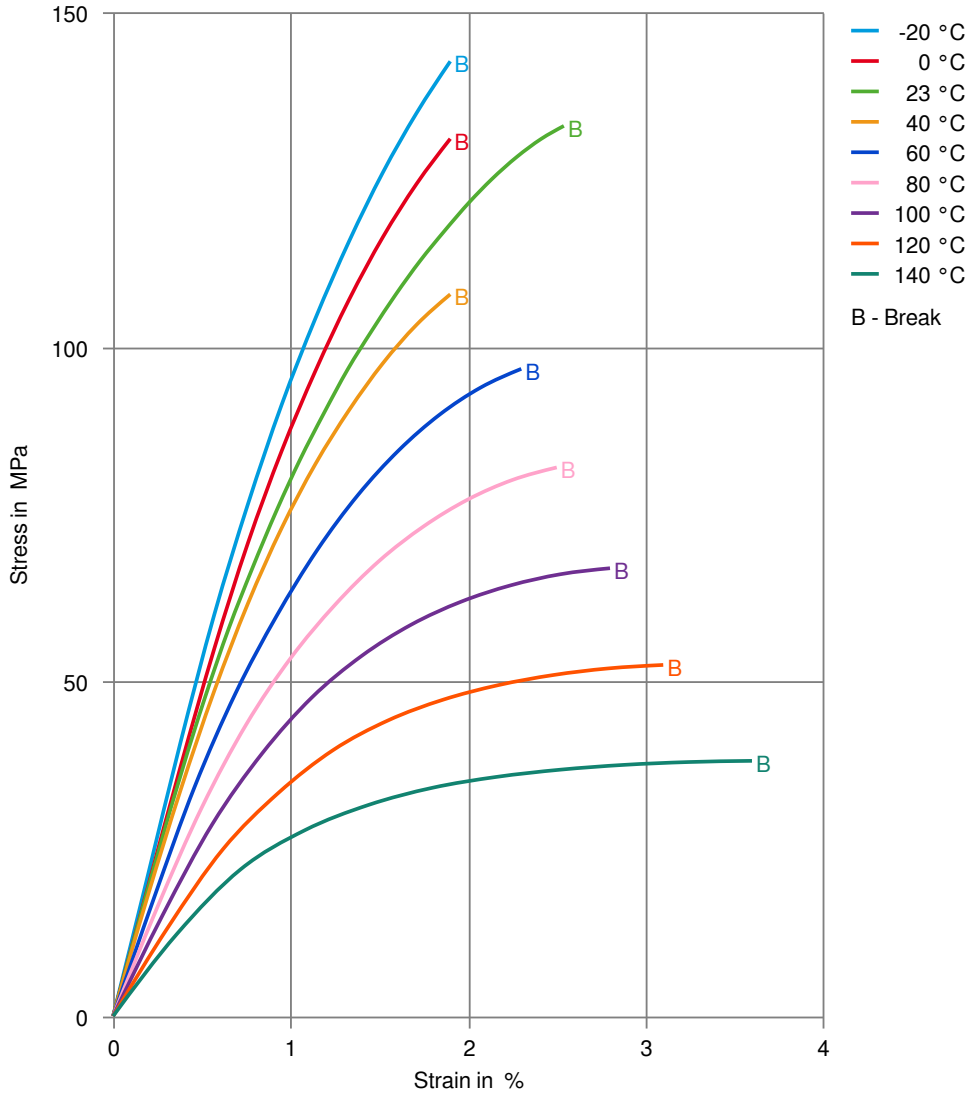
Stress-strain



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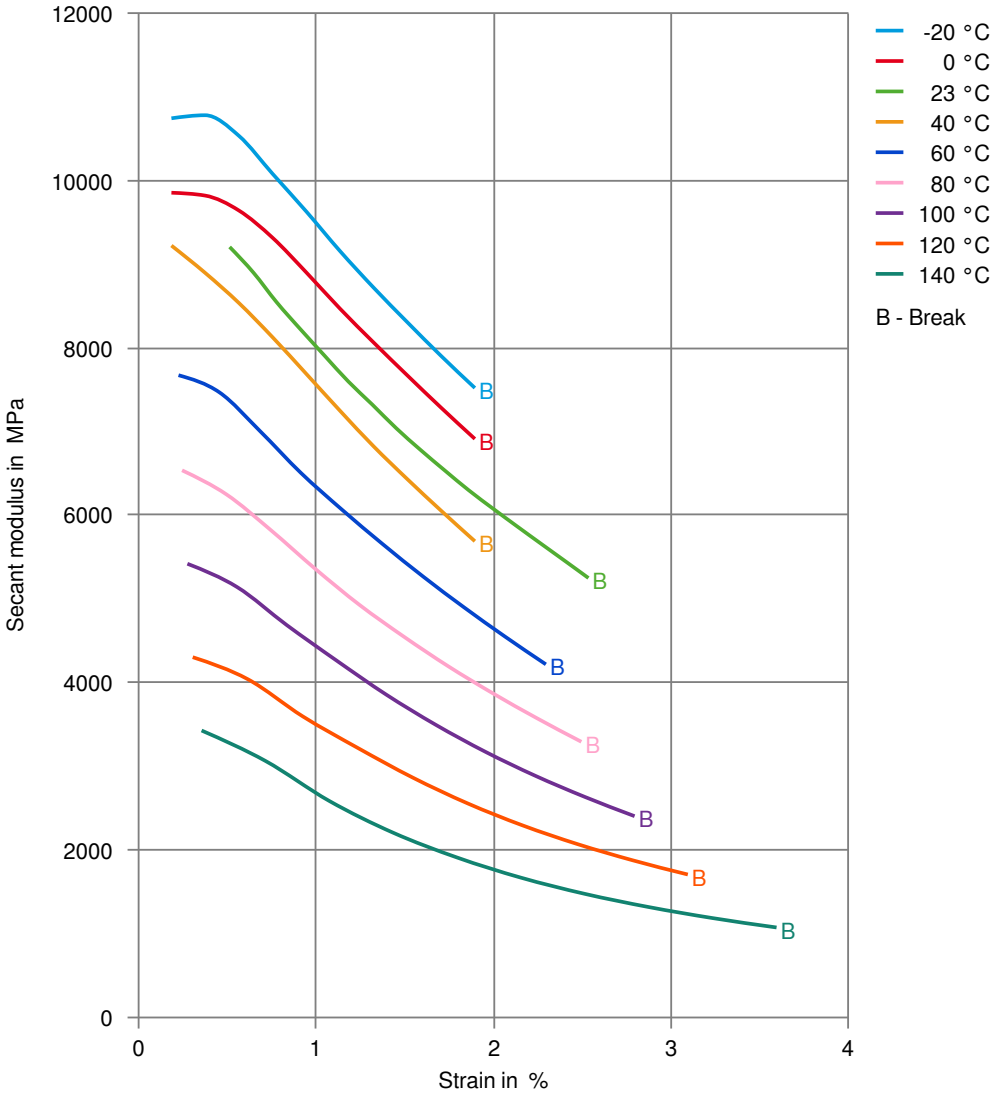
Secant modulus-strain



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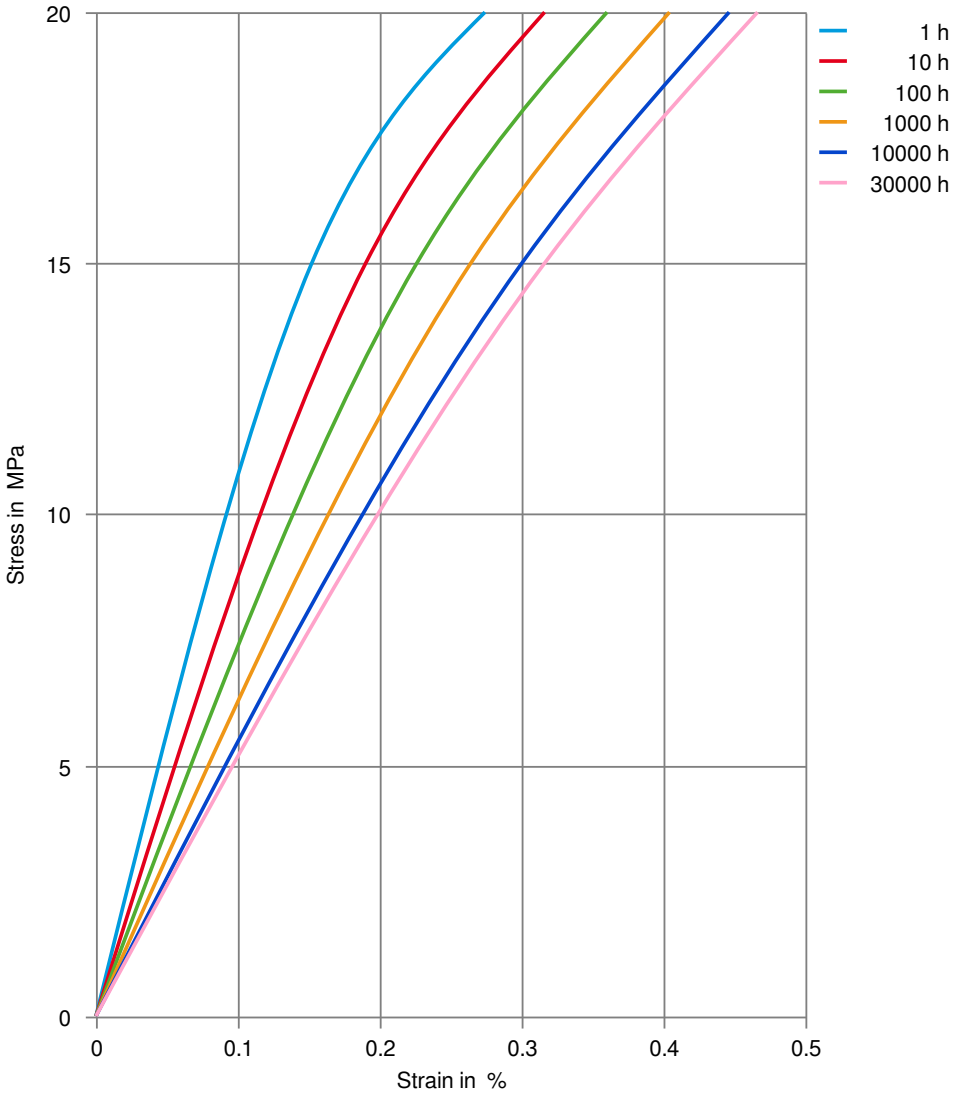
Stress-strain (isochronous) 80 °C



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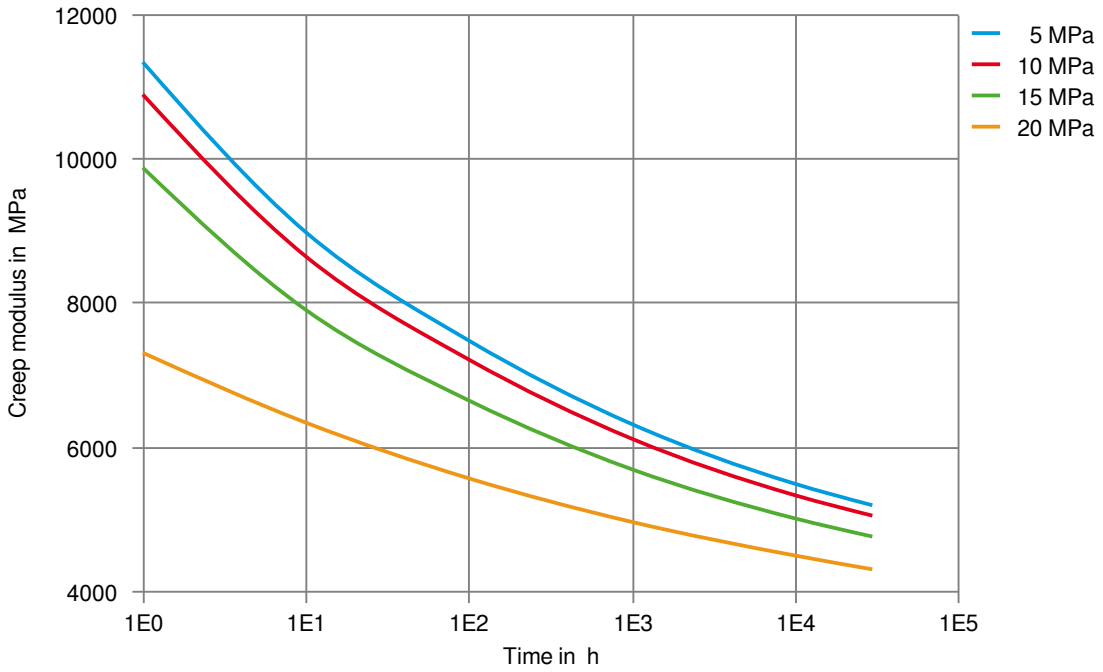
Creep modulus-time 80 °C



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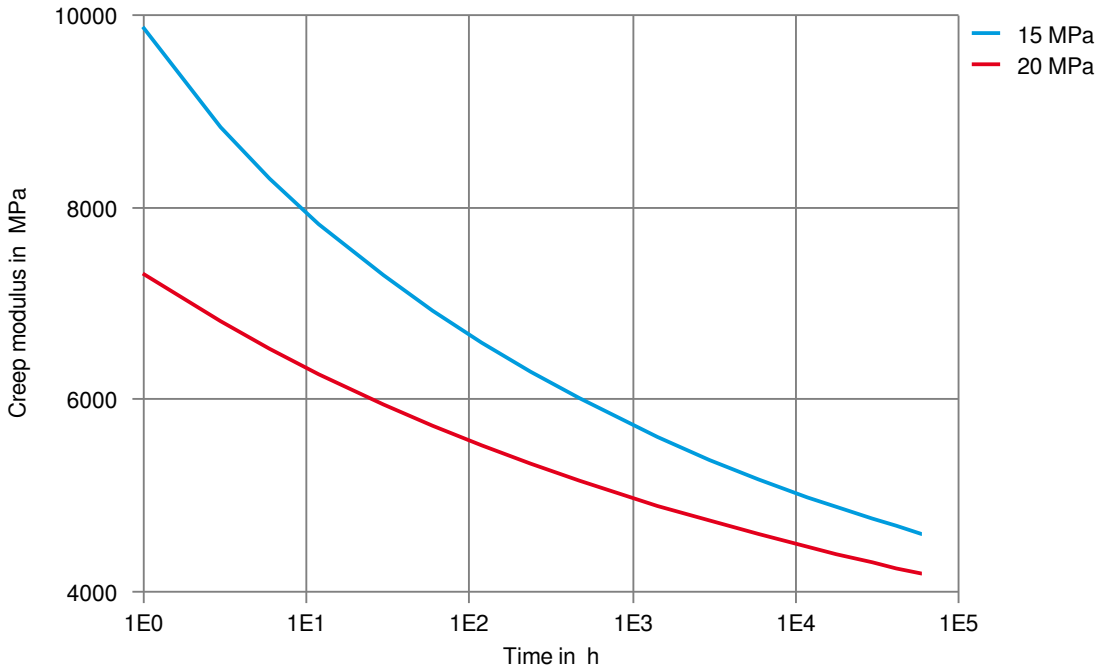
Creep modulus-time 85 °C



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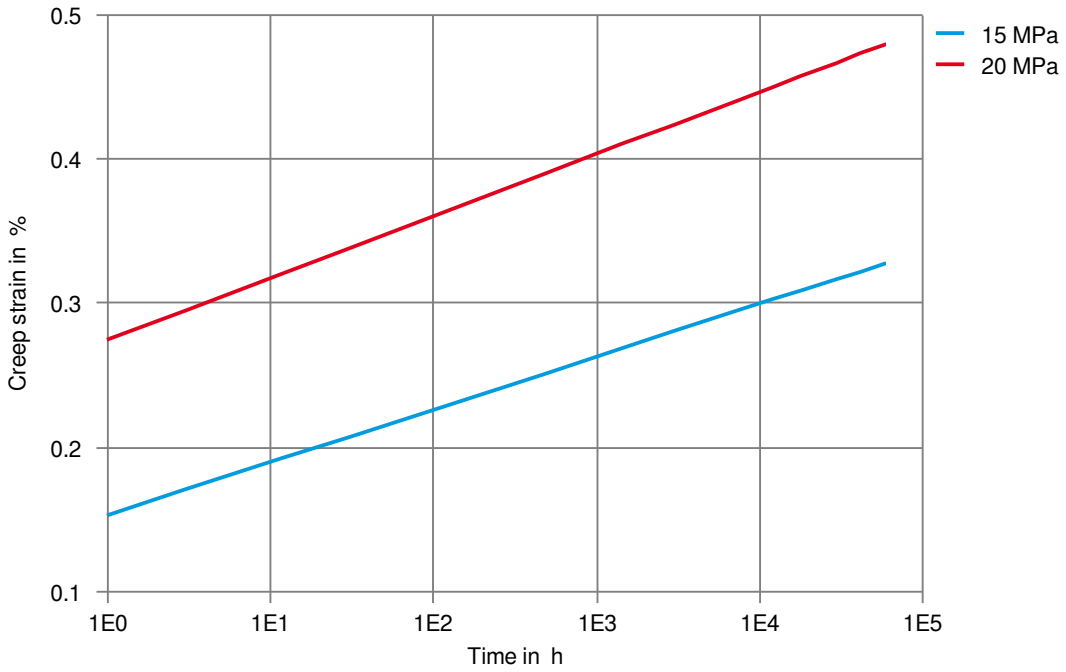
Creep strain-time 85 °C



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